

MM54HC534/MM74HC534 TRI-STATE® Octal D-Type Flip-Flop with Inverted Outputs

General Description

These high speed Octal D-Type Flip-Flops utilize advanced silicon-gate CMOS technology. They possess the high noise immunity and low power consumption of standard CMOS integrated circuits, as well as the ability to drive 15 LS-TTL loads. Due to the large output drive capability and the TRI-STATE feature, these devices are ideally suited for interfacing with bus lines in a bus organized system.

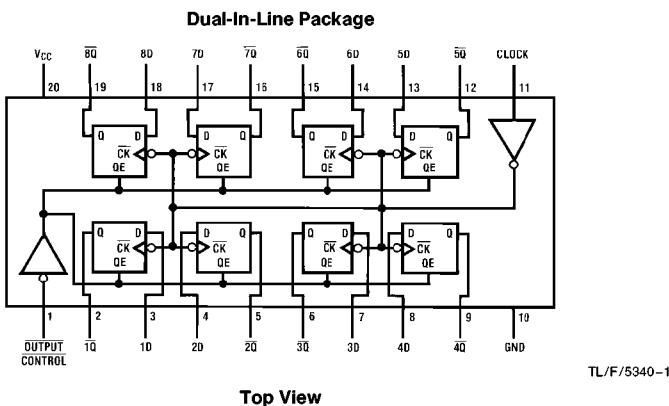
These devices are positive edge triggered flip-flops. Data at the D inputs, meeting the setup and hold time requirements, are inverted and transferred to the \bar{Q} outputs on positive going transitions of the CLOCK (CK) input. When a high logic level is applied to the OUTPUT CONTROL (OC) input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

The 54HC/74HC logic family is speed, function, and pinout compatible with the standard 54LS/74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

- Typical propagation delay: 23 ns
- Wide operating voltage range: 2–6V
- Low input current: 1 μ A maximum
- Low quiescent current: 80 μ A maximum
- Compatible with bus-oriented systems
- Output drive capability: 15 LS-TTL loads

Connection Diagram



Order Number MM54HC534 or MM74HC534

Truth Table

| Output Control | Clock | Data | Output |
|----------------|-------|------|-------------|
| L | ↑ | H | L |
| L | ↑ | L | H |
| L | L | X | \bar{Q}_0 |
| H | X | X | Z |

H = High Level, L = Low Level
 X = Don't Care
 ↑ = Transition from low-to-high
 Z = High impedance state
 \bar{Q}_0 = The level of the output before steady state input conditions were established

Absolute Maximum Ratings (Notes 1 & 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

| | |
|--|-------------------------|
| Supply Voltage (V_{CC}) | -0.5 to +7.0V |
| DC Input Voltage (V_{IN}) | -1.5 to V_{CC} + 1.5V |
| DC Output Voltage (V_{OUT}) | -0.5 to V_{CC} + 0.5V |
| Clamp Diode Current (I_{IK}, I_{OK}) | ± 20 mA |
| DC Output Current, per pin (I_{OUT}) | ± 35 mA |
| DC V_{CC} or GND Current, per pin (I_{CC}) | ± 70 mA |
| Storage Temperature Range (T_{STG}) | -65°C to +150°C |
| Power Dissipation (P_D) (Note 3) S.O. Package only | 600 mW 500 mW |
| Lead Temperature (T_L) (Soldering 10 seconds) | 260°C |

Operating Conditions

| | Min | Max | Units |
|---|---|--------------------|-------|
| Supply Voltage (V_{CC}) | 2 | 6 | V |
| DC Input or Output Voltage (V_{IN}, V_{OUT}) | 0 | V_{CC} | V |
| Operating Temp. Range (T_A) MM74HC | -40 | +85 | °C |
| MM54HC | -55 | +125 | °C |
| Input Rise or Fall Times (t_r, t_f) | $V_{CC} = 2.0V$ $V_{CC} = 4.5V$ $V_{CC} = 6.0V$ | 1000 500 400 | ns |

DC Electrical Characteristics (Note 4)

| Symbol | Parameter | Conditions | V_{CC} | $T_A = 25^\circ C$ | | $74HC$ | $54HC$ | Units |
|----------|--|---|----------------------|--------------------|--------------------|--------------------|--------------------|---------|
| | | | | Typ | Guaranteed Limits | | | |
| V_{IH} | Minimum High Level Input Voltage | | 2.0V 4.5V 6.0V | 1.5 3.15 4.2 | 1.5 3.15 4.2 | 1.5 3.15 4.2 | 1.5 3.15 4.2 | V |
| V_{IL} | Maximum Low Level Input Voltage** | | 2.0V 4.5V 6.0V | 0.5 1.35 1.8 | 0.5 1.35 1.8 | 0.5 1.35 1.8 | 0.5 1.35 1.8 | V |
| V_{OH} | Minimum High Level Output Voltage | $V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 20 \mu A$ | 2.0V 4.5V 6.0V | 2.0 4.5 6.0 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | 1.9 4.4 5.9 | V |
| | | $V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 6.0 \text{ mA}$ $ I_{OUT} \leq 7.8 \text{ mA}$ | 4.5V 6.0V | 4.2 5.7 | 3.98 5.48 | 3.84 5.34 | 3.7 5.2 | V |
| V_{OL} | Maximum Low Level Output Voltage | $V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 20 \mu A$ | 2.0V 4.5V 6.0V | 0 0 0 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | V |
| | | $V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 6.0 \text{ mA}$ $ I_{OUT} \leq 7.8 \text{ mA}$ | 4.5V 6.0V | 0.2 0.2 | 0.26 0.26 | 0.33 0.33 | 0.4 0.4 | V |
| I_{IN} | Maximum Input Current | $V_{IN} = V_{CC}$ or GND | 6.0V | | ± 0.1 | ± 1.0 | ± 1.0 | μA |
| I_{OZ} | Maximum TRI-STATE Output Leakage Current | $V_{IN} = V_{IH}$ or V_{IL} , OC = V_{IH} $V_{OUT} = V_{CC}$ or GND | 6.0V | | ± 0.5 | ± 5 | ± 10 | μA |
| I_{CC} | Maximum Quiescent Supply Current | $V_{IN} = V_{CC}$ or GND $I_{OUT} = 0 \mu A$ | 6.0V | | 8.0 | 80 | 160 | μA |

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: -12 mW/°C from 65°C to 85°C; ceramic "J" package: -12 mW/°C from 100°C to 125°C.

Note 4: For a power supply of 5V $\pm 10\%$ the worst case output voltages (V_{OH} and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN} , I_{CC} , and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

** V_{IL} limits are currently tested at 20% of V_{CC} . The above V_{IL} specification (30% of V_{CC}) will be implemented no later than Q1, CY'89.

AC Electrical Characteristics $V_{CC} = 5V$, $T_A = 25^\circ C$, $t_r = t_f = 6\text{ ns}$

| Symbol | Parameter | Conditions | Typ | Guaranteed Limit | Units |
|--------------------|--|--|-----|------------------|-------|
| f_{MAX} | Maximum Operating Frequency | | | 35 | MHz |
| t_{PHL}, t_{PLH} | Maximum Propagation Delay Clock to \bar{Q} | $C_L = 45\text{ pF}$ | 23 | 32 | ns |
| t_{PZH}, t_{PLZ} | Maximum Output Enable Time | $R_L = 1\text{ k}\Omega$ $C_L = 45\text{ pF}$ | 21 | 28 | ns |
| t_{PHZ}, t_{PLZ} | Maximum Output Disable Time | $R_L = 1\text{ k}\Omega$ $C_L = 5\text{ pF}$ | 19 | 25 | ns |
| t_S | Minimum Setup Time | | 10 | 20 | ns |
| t_H | Minimum Hold Time | | 0 | 5 | ns |
| t_W | Minimum Pulse Width | | 9 | 16 | ns |

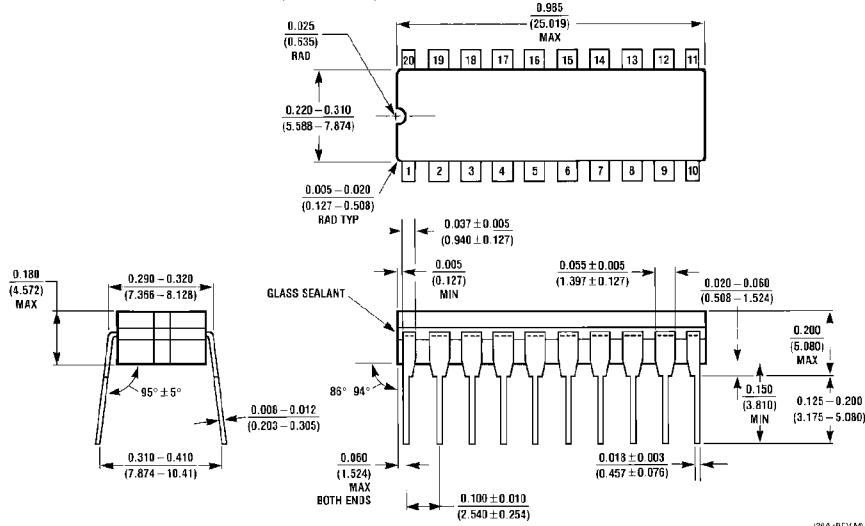
AC Electrical Characteristics $V_{CC} = 2.0\text{--}6.0V$, $C_L = 50\text{ pF}$, $t_r = t_f = 6\text{ ns}$ (unless otherwise specified)

| Symbol | Parameter | Conditions | V_{CC} | $T_A = 25^\circ C$ | | $74HC$ | $54HC$ | Units |
|--------------------|---|--|----------------------|----------------------|--------------------|----------------------------------|-----------------------------------|-------------------|
| | | | | Typ | | $T_A = -40\text{ to }85^\circ C$ | $T_A = -55\text{ to }125^\circ C$ | |
| f_{MAX} | Maximum Operating Frequency | $C_L = 50\text{ pF}$ | 2.0V 4.5V 6.0V | 2.0V 4.5V 6.0V | 6 30 35 | 5 24 28 | 4 20 23 | MHz MHz MHz |
| t_{PHL}, t_{PLH} | Maximum Propagation Delay, Clock to \bar{Q} | $C_L = 50\text{ pF}$ $C_L = 150\text{ pF}$ | 2.0V 2.0V | 68 110 | 180 230 | 225 288 | 270 345 | ns ns |
| | | $C_L = 50\text{ pF}$ $C_L = 150\text{ pF}$ | 4.5V 4.5V | 22 30 | 36 46 | 45 57 | 48 69 | ns ns |
| | | $C_L = 50\text{ pF}$ $C_L = 150\text{ pF}$ | 6.0V 6.0V | 20 28 | 31 40 | 39 50 | 46 60 | ns ns |
| t_{PZH}, t_{PLZ} | Maximum Output Enable Time | $R_L = 1\text{ k}\Omega$ | | | | | | |
| | | $C_L = 50\text{ pF}$ $C_L = 150\text{ pF}$ | 2.0V 2.0V | 50 80 | 150 200 | 189 250 | 225 300 | ns ns |
| | | $C_L = 50\text{ pF}$ $C_L = 150\text{ pF}$ | 4.5V 4.5V | 21 29 | 30 40 | 37 50 | 45 60 | ns ns |
| | | $C_L = 50\text{ pF}$ $C_L = 150\text{ pF}$ | 6.0V 6.0V | 19 25 | 26 35 | 31 44 | 39 53 | ns ns |
| t_{PHZ}, t_{PLZ} | Maximum Output Disable Time | $R_L = 1\text{ k}\Omega$ $C_L = 50\text{ pF}$ | 2.0V 4.5V 6.0V | 50 21 19 | 150 30 26 | 189 37 31 | 225 45 39 | ns ns ns |
| t_S | Minimum Setup Time | | 2.0V 4.5V 6.0V | | 50 9 9 | 60 13 11 | 75 15 13 | ns ns ns |
| t_H | Minimum Hold Time | | 2.0V 4.5V 6.0V | | 5 5 5 | 5 5 5 | 5 5 5 | ns ns ns |
| t_W | Minimum Pulse Width | | 2.0V 4.5V 6.0V | | 80 16 14 | 100 20 18 | 120 24 20 | ns ns ns |
| t_{THL}, t_{TLH} | Maximum Output Rise and Fall Time | $C_L = 50\text{ pF}$ | 2.0V 4.5V 6.0V | 25 7 6 | 60 12 10 | 75 15 13 | 90 18 15 | ns ns ns |
| t_r, t_f | Maximum Input Rise and Fall Time Clock | | | | 1000 500 400 | 1000 500 400 | 1000 500 400 | ns ns ns |
| C_{PD} | Power Dissipation Capacitance (Note 5) | (per flip-flop) $OC = V_{CC}$ $OC = Gnd$ | | 30 50 | | | | pF pF |
| C_{IN} | Maximum Input Capacitance | | | 5 | 10 | 10 | 10 | pF |
| C_{OUT} | Maximum Output Capacitance | | | 15 | 20 | 20 | 20 | pF |

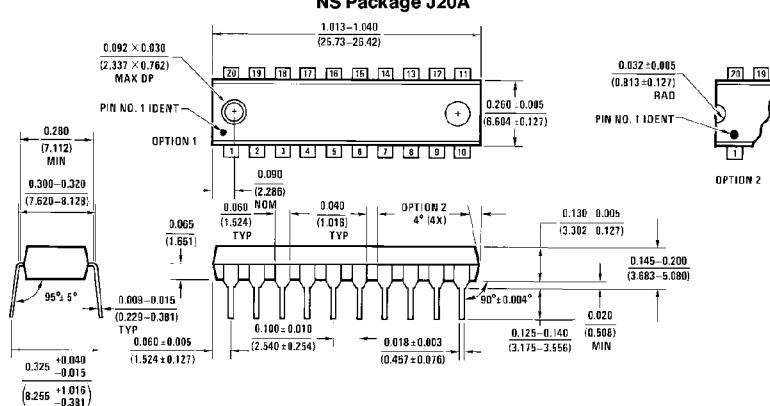
Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

MM54HC534/MM74HC534 TRI-STATE Octal D-Type Flip-Flop with Inverted Outputs

Physical Dimensions inches (millimeters)



Ceramic Dual-In-Line Package (J)
Order Number MM54HC534J or MM74HC534J
NS Package J20A



Molded Dual-In-Line Package (N)
Order Number MM74HC534N
NS Package N20A

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National Semiconductor
Corporation
1111 West Bardin Road
Arlington, TX 76017
Tel: (800) 272-9959
Fax: (800) 737-7018

National Semiconductor
Europe

Fax: (+49) 0-180-530 85 86
Email: cnjwge@tevm2.nsc.com
Deutsch Tel: (+49) 0-180-530 85 85
English Tel: (+49) 0-180-532 78 32
Français Tel: (+49) 0-180-532 93 58
Italiano Tel: (+49) 0-180-534 16 80

National Semiconductor
Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: (852) 2737-1600
Fax: (852) 2736-9960

National Semiconductor
Japan Ltd.
Tel: 81-043-299-2309
Fax: 81-043-299-2408

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